MLX90290 Datasheet

High Speed Factory Trimmed Linear Hall IC

1. Features and Benefits

- Linear Hall Sensor
- Small Size
- High Sensitivity
- High Accuracy
- High Speed
- Fast Start-Up for power gating in Micro-power applications
- Factory Programmed Customization
  - Sensitivity
  - Magnet Thermal Drift Compensation
  - Supply Voltage
- Automotive AEC Q-100 Qualified

2. Application Examples

- Linear Position Sensor
- Rotary Position Sensor
- Current Sensing
- Motor Commutation/Resolving

3. Description

The Melexis MLX90290 is a Second Generation linear Hall-effect sensor designed in mixed signal CMOS technology.

The device integrates a voltage regulator, Hall sensor with advanced offset cancellation system, and an analog output driver, in a single package.

The Output voltage is proportional to the applied magnetic field and to the chip supply voltage (ratiometric). Multiple sensitivity codes & magnet compensation options exist.

The Output Offset Level (Quiescent Level) at zero magnetic field is 50% of the chip supply voltage.

The device is offered in a RoHS compliant Thin Small Outline Transistor (TSOT) for surface mount and UA (TO-92) for Pin Through Hole mount.

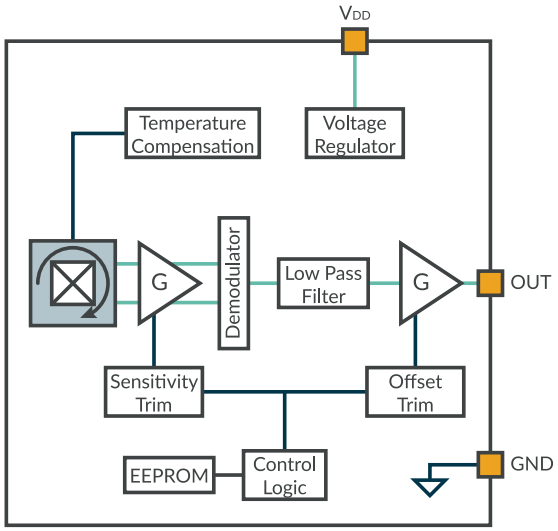


Figure 1 Functional Block Diagram MLX90290

Contents

4. Ordering Information

Product Code	Temperature Code	Package Code	Option Code	Packing Form Code
MLX90290	L	UA	AAA-XYZ	BU
MLX90290	L	SE	AAA-XYZ	RE

Legend:

Temperature Code: L: (-40°C to 150°C)

Package Code:
UA: TO-92-3L
SE: TSOT-3L

Option Code:

AAA-XYZ:
AAA = die version

X = V_{DDNOM} and trim & form options for UA package

- See Below Table: Package Options

Y= S

• 0:	18.8 mV/mT	@ 5V	Or	12.408 mV/mT	@ 3.3V
• 1:	25 mV/mT	@ 5V	Or	16.5 mV/mT	@ 3.3V
• 2:	31.25 mV/mT	@ 5V	Or	20.625 mV/mT	@ 3.3V
• 3:	50 mV/mT	@ 5V	Or	33 mV/mT	@ 3.3V
• 4:	100 mV/mT	@ 5V	Or	66 mV/mT	@ 3.3V
• 5:	39 mV/mT	@ 5V	Or	N/A	@ 3.3V

Z = TCS

- 0: 0 ppm/°C
- 1: 500 ppm/°C
- 2: 2000 ppm/°C
- 3: 650 ppm/°C

Important: S is expressed as mV/mT for 5V. This sensitivity scales with supply voltage.
E.g. Option 1 with 3.3V VDD supply voltage becomes 16.5mV/mT = 3.3/5*25mV/mT.

	Package Options	
Supply Voltage	**SE** **UA** with straight leads	**UA** with 2.54mm pitch, see section "UA package, trim and form"
3.3 V ± 5 %	X=3	X=4
5.0 V ± 10 %	X=5	X=6

Packing Form:
RE = Reel for SE or UA
CR = Radial Tape for UA (Carton Tape on Reel)
CA = Radial Tape for UA (Carton Tape in Ammopack)
BU = Bulk for SE or UA

Ordering example: MLX90290-LUA-AAA-612-CR. This ordering code indicates a 5V supply part in TO92 (UA) component with leads separated to achieve a 2.54mm pitch delivered in Carton Tape on Reel. The sensitivity corresponds to 25mV/mT and a thermal coefficient of +2000 ppm/°C to compensate for the magnet thermal drift (assumed to be a ferrite magnet).

Ordering Code	Package	Supply Voltage	Absolute Sensitivity	TC	Lead Forming	Packing Form(1)
MLX90290LSE-AAA-300-RE	TSOT-3L	3.3V	12.408mV/mT(2)	0ppm/°C	N/A	Plastic Tape on Reel
MLX90290LSE-AAA-310-RE	TSOT-3L	3.3V	16.5mV/mT(2)	0ppm/°C	N/A	Plastic Tape on Reel
MLX90290LSE-AAA-320-RE	TSOT-3L	3.3V	20.625mV/mT(2)	0ppm/°C	N/A	Plastic Tape on Reel
MLX90290LSE-AAA-321-RE	TSOT-3L	3.3V	20.625mV/mT(2)	500ppm/°C	N/A	Plastic Tape on Reel
MLX90290LSE-AAA-332-RE	TSOT-3L	3.3V	33mV/mT(2)	2000ppm/°C	N/A	Plastic Tape on Reel
MLX90290LSE-AAA-510-RE	TSOT-3L	5V	25mV/mT	0ppm/°C	N/A	Plastic Tape on Reel
MLX90290LSE-AAA-511-RE	TSOT-3L	5V	25mV/mT	500ppm/°C	N/A	Plastic Tape on Reel
MLX90290LSE-AAA-520-RE	TSOT-3L	5V	31.25mV/mT	0ppm/°C	N/A	Plastic Tape on Reel
MLX90290LSE-AAA-521-RE	TSOT-3L	5V	31.25mV/mT	500ppm/°C	N/A	Plastic Tape on Reel
MLX90290LSE-AAA-522-RE	TSOT-3L	5V	31.25mV/mT	2000ppm/°C	N/A	Plastic Tape on Reel
MLX90290LSE-AAA-553-RE	TSOT-3L	5V	39mV/mT	650ppm/°C	N/A	Plastic Tape on Reel
MLX90290LSE-AAA-530-RE	TSOT-3L	5V	50mV/mT	0ppm/°C	N/A	Plastic Tape on Reel
MLX90290LSE-AAA-531-RE	TSOT-3L	5V	50mV/mT	500ppm/°C	N/A	Plastic Tape on Reel
MLX90290LSE-AAA-532-RE	TSOT-3L	5V	50mV/mT	2000ppm/°C	N/A	Plastic Tape on Reel
MLX90290LSE-AAA-540-RE	TSOT-3L	5V	100mV/mT	0ppm/°C	N/A	Plastic Tape on Reel
MLX90290LUA-AAA-500-BU	TO92-3L	5V	18.8mV/mT	0ppm/°C	Std 1.27mm	Bulk
MLX90290LUA-AAA-500-RE	TO92-3L	5V	18.8mV/mT	0ppm/°C	Std 1.27mm	Plastic Tape on Reel
MLX90290LUA-AAA-510-BU	TO92-3L	5V	25mV/mT	0ppm/°C	Std 1.27mm	Bulk
MLX90290LUA-AAA-510-RE	TO92-3L	5V	25mV/mT	0ppm/°C	Std 1.27mm	Plastic Tape on Reel

Ordering Code	Package	Supply Voltage	Absolute Sensitivity	TC	Lead Forming	Packing Form(1)
MLX90290LUA-AAA-511-BU	TO92-3L	5V	25mV/mT	500ppm/°C	Std 1.27mm	Bulk
MLX90290LUA-AAA-512-BU	TO92-3L	5V	25mV/mT	2000ppm/°C	Std 1.27mm	Bulk
MLX90290LUA-AAA-612-CR	TO92-3L	5V	25mV/mT	2000ppm/°C	2.54mm spread	Carton Tape on Reel
MLX90290LUA-AAA-520-BU	TO92-3L	5V	31.25mV/mT	0ppm/°C	Std 1.27mm	Bulk
MLX90290LUA-AAA-520-CR	TO92-3L	5V	31.25mV/mT	0ppm/°C	Std 1.27mm	Carton Tape on Reel
MLX90290LUA-AAA-620-CR	TO92-3L	5V	31.25mV/mT	0ppm/°C	2.54mm spread	Carton Tape on Reel
MLX90290LUA-AAA-521-BU	TO92-3L	5V	31.25mV/mT	500ppm/°C	Std 1.27mm	Bulk
MLX90290LUA-AAA-522-BU	TO92-3L	5V	31.25mV/mT	2000ppm/°C	Std 1.27mm	Bulk
MLX90290LUA-AAA-530-BU	TO92-3L	5V	50mV/mT	0ppm/°C	Std 1.27mm	Bulk
MLX90290LUA-AAA-531-BU	TO92-3L	5V	50mV/mT	500ppm/°C	Std 1.27mm	Bulk
MLX90290LUA-AAA-631-CA	TO92-3L	5V	50 mV/mT	500ppm/°C	2.54mm spread	Carton Tape in Ammopack
MLX90290LUA-AAA-631-CR	TO92-3L	5V	50 mV/mT	500ppm/°C	2.54mm spread	Carton Tape on Reel
MLX90290LUA-AAA-532-BU	TO92-3L	5V	50mV/mT	2000ppm/°C	Std 1.27mm	Bulk
MLX90290LUA-AAA-540-BU	TO92-3L	5V	100mV/mT	0ppm/°C	Std 1.27mm	Bulk
MLX90290LUA-AAA-541-BU	TO92-3L	5V	100mV/mT	500ppm/°C	Std 1.27mm	Bulk
MLX90290LUA-AAA-542-BU	TO92-3L	5V	100mV/mT	2000ppm/°C	Std 1.27mm	Bulk
MLX90290LUA-AAA-553-BU	TO92-3L	5V	39mV/mT	650ppm/°C	Std 1.27mm	Bulk

Table 1 Available option codes in production

The above option codes are all released in production. An option code refers to the sensitivity and magnet compensation. In order to obtain a not listed option code in Table 1, please contact your local Sales Representative to explore the options of customization during Melexis factory trimming.

(1) Melexis can provide for a given option code a different packing forms, such as –RE for TSOT-3L surface mount package and –BU, –CR or –CA for TO92-3L through hole package. So, it is possible to obtain a different packing form for a product listed in Table 1.
(2) Sensitivity scaled for 3.3V supply.

Note: Delivery in bulk (packing form code BU) may cause some parts to have lead pitch and coplanarity deviation due to transport stress.
Especially when a fully automatic assembly process is applied by customer, Melexis recommends ordering parts on cardboard radial tape in ammopack (packing form code CA) or reel (packing form code CR) packing.

5. Glossary of Terms

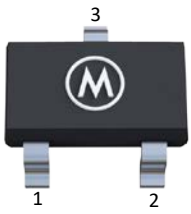
Name	Definition
Tesla [T]	Units of magnetic flux density: 1mT = 10 Gauss
ESD	Electro-Static Discharge
TSOT	Thin Small Outline Transistor package
PSRR	Power Supply Rejection Ratio
SMD	Surface Mount Devices
THD	Through Hole Device
RoHS	Restriction of Hazardous Substances

Table 2

6. Pin Definitions and Descriptions

SE Pin №	UA Pin №	Name	Type	Function
1	1	VDD	Supply	Supply Voltage
2	3	OUT	I/O	Analog Output
3	2	GND	Ground	Ground

UA package



SE package

Table 3 Pin Definitions and Descriptions

7. Absolute Maximum Ratings

Operating Characteristics, V_{DD} = 3.15V to 5.5V, T_A = -40°C to 150°C, C1 ≥ 0.1µF (unless otherwise specified)

Parameter	Symbol	Value	Units
Supply Voltage	V_{DD}	-0.3 to 7	V
Supply Current[1]	I_{DD}	±20	mA
Output Voltage	V_{OUT}	-0.3 to V_{DD}+0.3	V
Output Current[1]	I_{OUT}	±20	mA
Operating Temperature Range	T_A	-40 to 150	°C
Maximum Junction Temperature	T_J	165	°C
Storage Temperature Range	T_S	-55 to 165	°C
ESD Sensitivity (Human Body Model)[2]	ESD_{HBM}	8	kV
ESD Sensitivity (Charged Device Model)[3]	ESD_{CDM}	500	V
Maximum Flux Density	B	> 1000	mT

Table 4 Absolute Maximum Ratings

Exceeding the absolute maximum ratings may cause permanent damage. Exposure to absolute maximum-rated conditions for extended periods may affect device reliability.

[1] Including the current flowing through the protection structure. Maximum power dissipation should be also considered
[2] *Human Body Model according AEC-Q100-002 standard*
[3] *Charged Device Model according AEC-Q100-011 standard*

8. General Electrical Specifications

Operating Characteristics, V_{DD} = 3.15V to 5.5V, T_A = -40°C to 150°C, C1 ≥ 0.1µF (unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ[4]	Max	Units
Supply Voltage	V_{DD}	Operating	3.15	-	5.5	V
Supply Current	I_{DD}		3	5	8	mA
Reset Voltage	V_{POR}	OUT → High Impedance	-	2.7	2.95	V
Load Current Range	I_{OUT}		-1	-	1	mA
Load Resistance Range	R_L	Connected between OUT and GND	5	-	Infinite	kΩ
Load Capacitor Range[5]	C_L	Connected between OUT and GND	0	10	100 with R_S=50Ω	nF
Output Saturation Voltage	V_{OSHI}	I_{OUT}= -1mA, B=1.1*(V_{DD} - V_{OQ})/S	V_{DD} - 0.25	-	V_{DD}	V
	V_{OSHI}[5]	I_{OUT}= -0.1mA, B=1.1*(V_{DD} - V_{OQ})/S	V_{DD} - 0.1	-	V_{DD}	V
	V_{OSLO}	I_{OUT}=1mA, B=1.1*(-V_{OQ})/S	0	-	0.25	V
	V_{OSLO}[5]	I_{OUT}=0.1mA, B=1.1*(-V_{OQ})/S	0	-	0.1	V
Output Resistance	R_{OUT}	I_{OUT}= ±1mA	-	1.5	5	Ω
Power-On Time[6,7]	t_{ON}	V_{DD}=V_{DDNOM}[8], B=0.4/S_{REL}, dV_{DD}/dt>2V/us	-	40	70	µs
Chopping Frequency	F_{CHOP}		-	900	-	kHz
Sample / Update Period	T_{SAMPLE}	T_{SAMPLE}=1/F_{CHOP}	-	1.1	-	us
Power Supply Rejection Ratio[5]	PSRR	From 80kHz to 200kHz	20	-	-	dB
Package Thermal Resistance Junction to Ambient	R_{THJA}	TSOT-3L	-	230	-	°C/W
		3-SIP-UA / TO92-UA	-	180	-	°C/W

Table 5 : General Electrical Specification

[4] Typical values are defined at TA = 25°C and VDD = VDDNOM
[5] Guaranteed by design and characterization
[6] The Power-On Time represents the time from reaching VDD = 3.15V to VOUT settled within ±5% from its final value
[7] Power-On Slew Rate is not critical for the proper device start-up
[8] VDDNOM = 5V or 3.3V - the value used at trimming

9. Sensor Specific Specifications

Operating Characteristics, V_{DD} = 3.15V to 5.5V, T_A = -40°C to 150°C, C1 ≥ 0.1µF (unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ[9]	Max	Units
Sensitivity Accuracy	εS	T_A=25°C, V_{DD}=V_{DDNOM}[10]	-5	-	5	%
Sensitivity Ratiometry	ε^RS		-2.5	-	2.5	% / V
Linearity	Lin	V_{DD}=V_{DDNOM}[10]	-1.5	-	1.5	%
Symmetry	Sym	V_{DD}=V_{DDNOM}[10]	-1.5	-	1.5	%
Relative Output Offset Level	V_{OQREL}	B=0mT, T_A=25°C, V_{DD}=V_{DDNOM}[10]	0.49	0.5	0.51	-
Thermal Offset Drift	$\varepsilon^T V_{OQ}$[11]	B=0mT, V_{DD}=V_{DDNOM}[10] S in [mV/mT]	-(25mV+0.9mT*S)	0	+(25mV+0.9mT*S)	-
Output Offset Ratiometry	$\varepsilon^R V_{OQREL}$	B=0mT	-2.5	-	2.5	% / V
Signal Bandwidth	BW	At -3dB, B<0.4/S_{REL}, UA package SOT package	 15[12] 25[12]	 30[12] 50[12]	 -	kHz
Signal Phase Shift	PHI	Sine wave magnetic field at F = 1 kHz UA package SOT package	 -	 3.6[12] 2.4[12]	 5[12] 3.2[12]	Degree
Sensitivity Range	S	V_{DD}=V_{DDNOM}[10]	9.9 15	-	66 100	mV/mT@3.3V mV/mT @5V
Sensitivity Temperature Coefficient	TCS	V_{DD}=V_{DDNOM}[10]	0		2000	ppm/°C

Table 6 Magnetic specification

[9] Typical values are defined at TA = 25ºC and VDD = VDDNOM
*[10] VDDNOM = 5V or 3.3V - the value used at trimming. This sensitivity scales with supply voltage. E.g. Y=1 with 3.3V VDD supply voltage becomes 16.5mV/mT = 3.3/5*25mV/mT.*
[11] Guaranteed by design and characterization
[12] Signal Bandwidth & Signal Phase Shift mentioned here are defined for Z=1 & 2, resp. 500ppm/ºC & 2000ppm/ºC. The option code Z=0 has internal filtering disabled. Products for 0ppm/ºC are targeted for current measurement applications. Therefore, Bandwidth & Phase Shift are not specified. No internal filter enables a step response time in the order of us. To get an idea of the phase & amplitude behavior over frequency, use a bode diagram for a 1st order RC filter with the Frequencies specified under "Band width". Also note that Melexis can support you to get an application specific filter setting. Contact your sales contact in such case.

Parameter	Code	Symbol	Test Conditions	Min	Typ	Max	Units
Sensitivity Temperature Coefficient	Z = 0	TCS_{-40} [11]	T_A= -40°C, $V_{DD}=V_{DDNOM}$ [10]		0		ppm/°C
		TCS_{150} [13]	T_A=150°C, $V_{DD}=V_{DDNOM}$ [10]		0		ppm/°C
	Z = 1	TCS_{-40} [11]	T_A= -40°C, $V_{DD}=V_{DDNOM}$ [10]	0	650	1300	ppm/°C
		TCS_{150} [13]	T_A=150°C, $V_{DD}=V_{DDNOM}$ [10]	0	500	1000	ppm/°C
	Z = 2	TCS_{-40} [11]	T_A= -40°C, $V_{DD}=V_{DDNOM}$ [10]	1100	2000	2900	ppm/°C
		TCS_{150} [13]	T_A=150°C, $V_{DD}=V_{DDNOM}$ [10]	1100	2000	2900	ppm/°C
	Z = 3	TCS_{-40} [11]	T_A= -40°C, $V_{DD}=V_{DDNOM}$ [10]	0	650	1300	ppm/°C
		TCS_{150} [13]	T_A=150°C, $V_{DD}=V_{DDNOM}$ [10]	0	500	1000	ppm/°C
Sensitivity Range (factory trimmed)	Y = 0	S	$V_{DD}=V_{DDNOM}$ [10]		12.4 18.8		mV/mT@3.3V mV/mT@5V
	Y = 1	S	$V_{DD}=V_{DDNOM}$ [10]		16.5 25		mV/mT@3.3V mV/mT@5V
	Y = 2	S	$V_{DD}=V_{DDNOM}$ [10]		20.625 31.25		mV/mT@3.3V mV/mT@5V
	Y = 3	S	$V_{DD}=V_{DDNOM}$ [10]		33 50		mV/mT@3.3V mV/mT@5V
	Y = 4	S	$V_{DD}=V_{DDNOM}$ [10]		66 100		mV/mT@3.3V mV/mT@5V
	Y =5	S	$V_{DD}=V_{DDNOM}$ [10]		N/A 39		mV/mT@3.3V mV/mT@5V

Table 7 Available Settings

[13] *Guaranteed by correlation with wafer test and characterization*

10. Detailed General Description

10.1. Characteristic Definitions

The Sensor DC Output Voltage is defined by:

$V_{OUT} = V_{DD} \cdot (V_{OQREL} + S_{REL} \cdot B)$, $[V]$, where:

$V_{OQREL} = \frac{V_{OQ}}{V_{DD}}$, $\left[\frac{V}{V}\right]$ is the measured relative quiescent output voltage, its nominal value is 0.5;

$V_{OQ} = V_{OUT}$, $[V]$ is the measured quiescent output voltage at $B = 0$;

$S_{REL} = \frac{S}{V_{DD}} = \frac{\Delta V_{OUT}}{\Delta B} \cdot \frac{1}{V_{DD}}$, $\left[\frac{1}{T}\right]$ is the relative magnetic sensitivity;

$S = \frac{\Delta V_{OUT}}{\Delta B} = S_{REL} \cdot V_{DD}$, $\left[\frac{V}{T}\right]$ is the magnetic sensitivity at given supply voltage V_{DD}.

Magnetic Sensitivity Temperature Coefficient TCS is defined by:

$$TCS = \frac{S_{REL}(T_A) - S_{REL}(25°C)}{S_{REL}(25°C) \cdot (T_A - 25°C)} \cdot 10^6, \left[\frac{ppm}{°C}\right].$$

Magnetic Sensitivity Ratiometry is defined by:

$$\varepsilon^R S = \frac{S_{REL}(V_{DD}) - S_{REL}(V_{DDNOM})}{S_{REL}(V_{DDNOM}) \cdot (V_{DD} - V_{DDNOM})} \cdot 100\%, \left[\frac{\%}{V}\right].$$

Linearity for both positive and negative magnetic fields is defined by:

$Lin = \frac{S_{REL}(B_2) - S_{REL}(B_1)}{S_{REL}(B_1)} \cdot 100\%$, $[\%]$, where $B_1 = \pm\frac{0.2}{S_{REL}}$, $B_2 = \pm\frac{0.4}{S_{REL}}$ and

$$S_{REL}(B_X) = \frac{V_{OUT}(B_X) - V_{OQ}}{B_X \cdot V_{DD}}.$$

Symmetry for positive and negative magnetic fields is defined by:

$Sym = \frac{S_{REL}(B_2) - S_{REL}(B_1)}{\frac{1}{2}(S_{REL}(B_1) + S_{REL}(B_2))} \cdot 100\%$, $[\%]$, where $B_1 = \frac{0.4}{S_{REL}}$, $B_2 = -\frac{0.4}{S_{REL}}$ and

$$S_{REL}(B_X) = \frac{V_{OUT}(B_X) - V_{OQ}}{B_X \cdot V_{DD}}.$$

Output Offset Temperature Drift is defined by:

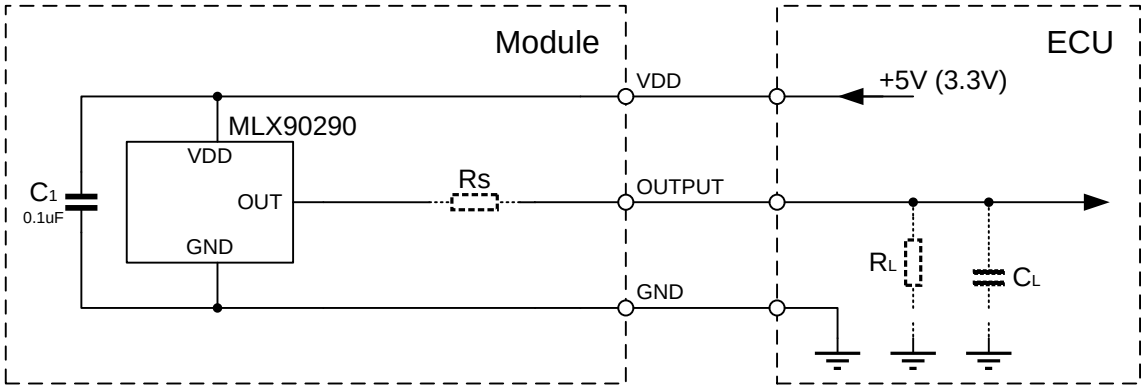
$$\varepsilon^T V_{OQ} = V_{OQ}(T_A) - V_{OQ}(25°C), \left[mV\right].$$

Output Offset Ratiometry is calculated by:

$$\varepsilon^R V_{OQREL} = \frac{V_{OQREL}(V_{DD}) - V_{OQREL}(V_{DDNOM})}{V_{OQREL}(V_{DDNOM}) \cdot (V_{DD} - V_{DDNOM})} \cdot 100\%, \left[\frac{\%}{V}\right].$$

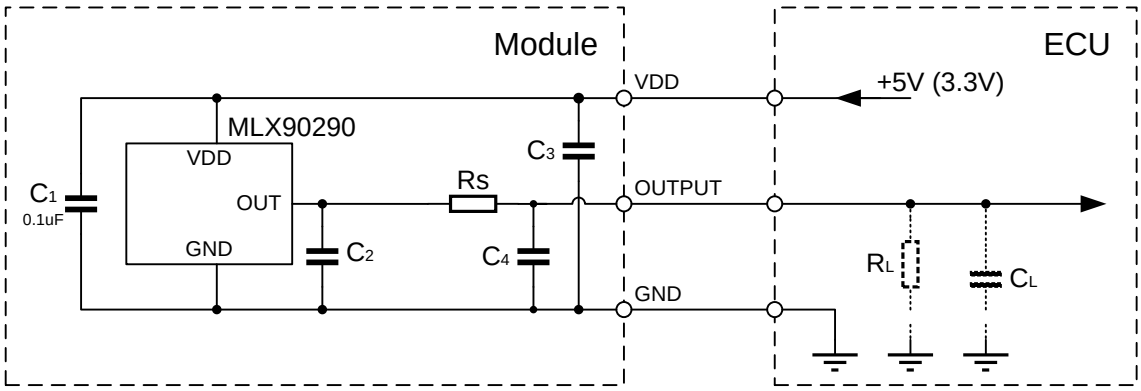
11. Application Information

11.1. Typical Application Diagram



Notes:
For proper operation a 100nF or bigger bypass capacitor C1 should be placed as close as possible to the VDD and GND pins of MLX90290.
For embedded applications the components R_S, R_L and C_L are not required.

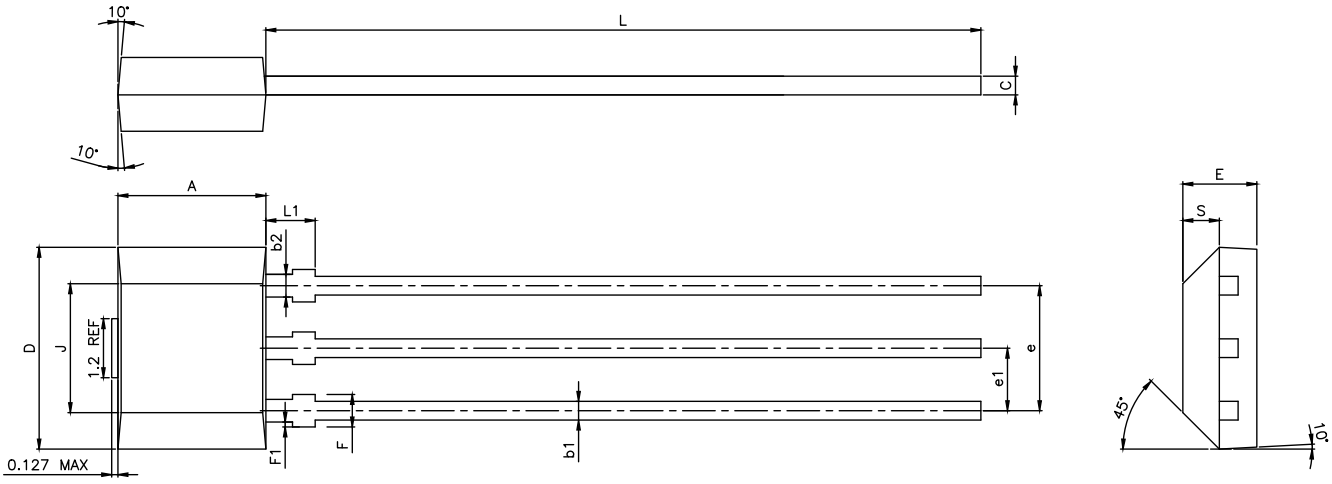
11.2. Application Circuit for Harsh and Noisy Environment



Notes:
For proper operation a 100nF or bigger bypass capacitor C1 should be placed as close as possible to the VDD and GND pins of MLX90290. For harsh and noisy environment, a bypass capacitor C2 of 1nF to 10nF can be placed on the output. For improved EMC performance an additional resistance, Rs and capacitors, C3 and C4 placed close to the connector of the module are recommended. Recommended values for: Rs ≥ 50E, 1nF ≥ C3 ≤ 4.7nF, 1nF ≥ C4 ≤ 10nF.
For embedded applications the components R_L and C_L are not required.

12. Package Information –Example from MLX90290

12.1. UA (TO92-3L) Package Information



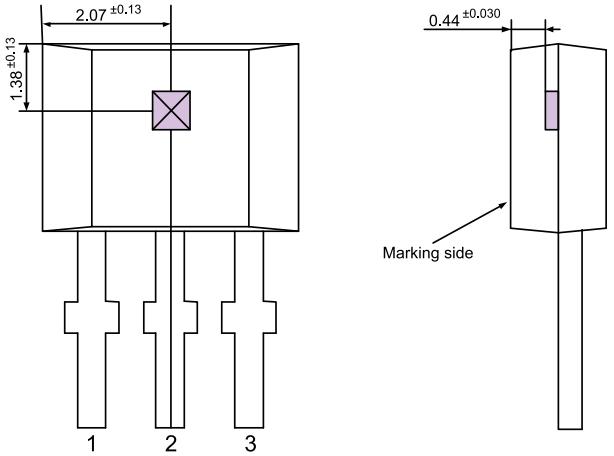
	A	D	E	F	F1	J	L	L1	S	b1	b2	c	e	e1
min	2.90	4.00	1.45	0.45	0.00	2.51	14.0	0.90	0.63	0.35	0.43	0.35	2.49	1.22
max	3.10	4.20	1.55	0.66	0.15	2.72	15.0	1.10	0.84	0.44	0.53	0.44	2.59	1.32

Notes:

1. Dimensions in millimeters (mm) unless noted otherwise.
2. Package dimensions do not include mold flashes and protrusions.
3. Dimension A and D do not include mold gate and side flash (protrusion) of maximum 0.127 mm per side.

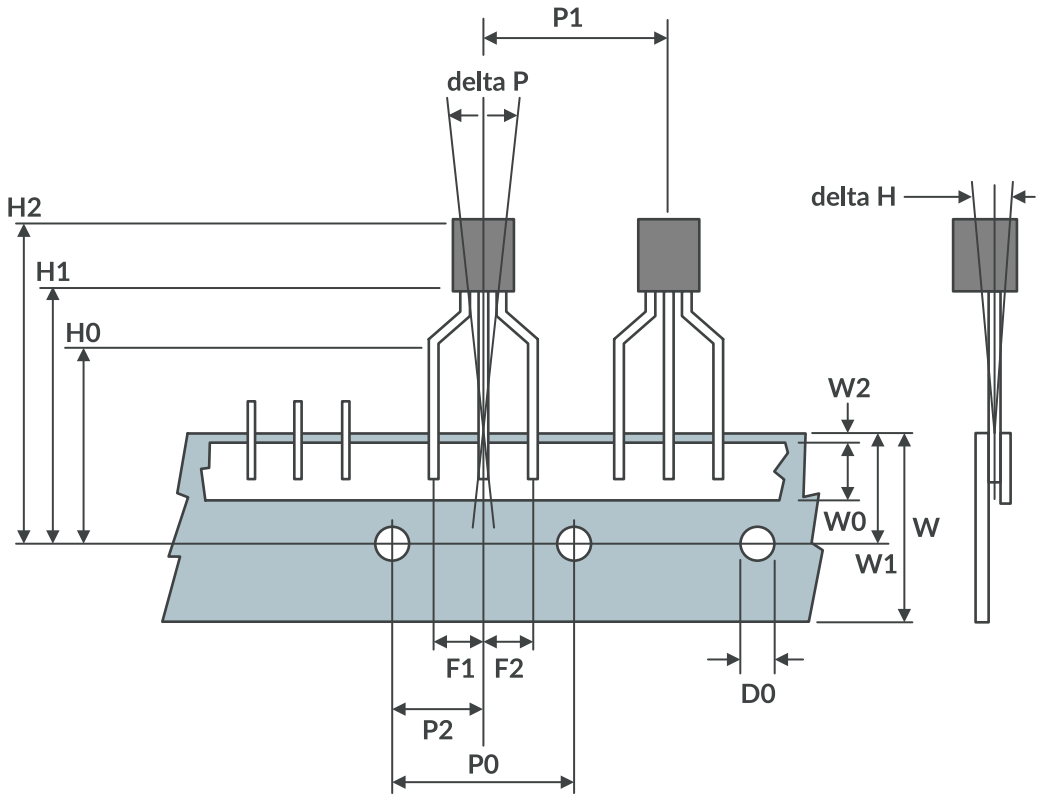
12.2. UA (TO92-3L) Hall Plate Location

Hall plate location



Notes
1. All dimensions are in millimeters
2. Mold flashes and protrusion are not included

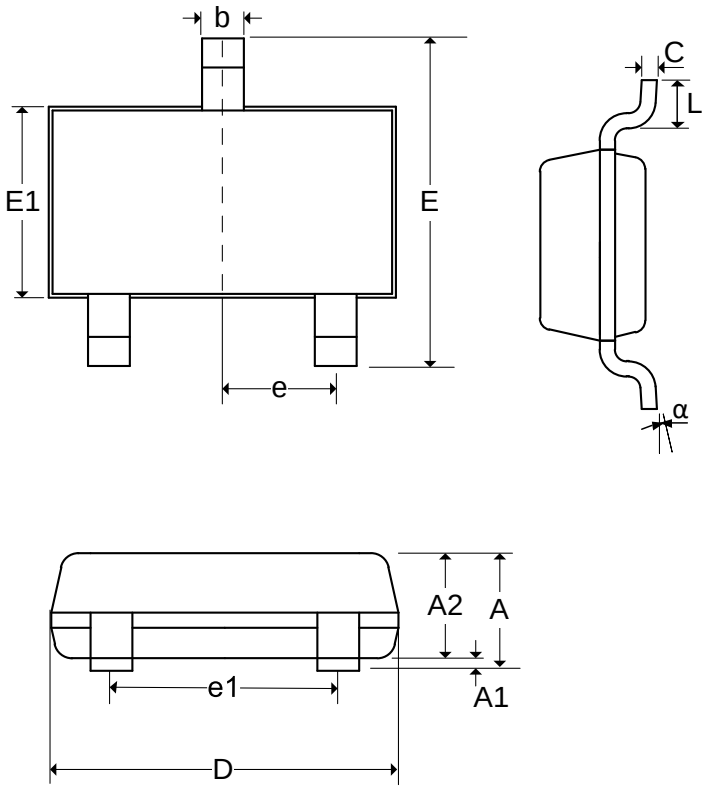
12.2.1. Trim and form with 2.54mm distance between leads; only available on tape



Parameter	Component Height	Component Position	Hole Diameter	Hole Position	Hole Pitch	Component Pitch	Right-Left Bending
	H1	P2	Do	W1	Po	P1	ΔP
Nominal (& Tolerance)	19mm (±0.5)	6.35mm (±0.4)	4mm (±0.2)	9mm (-0.5; +0.75)	12.7mm (±0.3)	12.7mm (±0.3)	±0.4mm

Parameter	Lead Spacing	Front-Rear Bending	Tape Width	Adhesive Tape Width	Adhesive to Carrier Tape Gap	Vertical Lead Length	Component Height Top
	F1 & F2	ΔH	W	Wo	W2	H0	H2
Nominal (& Tolerance)	2.54mm (±0.25mm)	±.0.3deg	18mm (±0.5)	6mm (±0.2)	0.5mm (-0.5; +0.3)	15.5mm (±0.5)	22.0mm (±0.8mm)

12.3. SE (TSOT-3L) Package Information



Notes:

1. All dimensions are in millimeters
2. Outermost plastic extreme width does not include mold flash or protrusions. Mold flash and protrusions shall not exceed 0.15mm per side.
3. Outermost plastic extreme length does not include mold flash or protrusions. Mold flash and protrusions shall not exceed 0.25mm per side.
4. The lead width dimension does not include dambar protrusion. Allowable dambar protrusion shall be 0.07mm total in excess of the lead width dimension at maximum material condition.
5. Dimension is the length of terminal for soldering to a substrate.
6. Formed lead shall be planar with respect to one another with 0.076mm at seating plane.

Marking:

Top side :

90XXX
XXX: Last three digits of the lot

Bottom side:

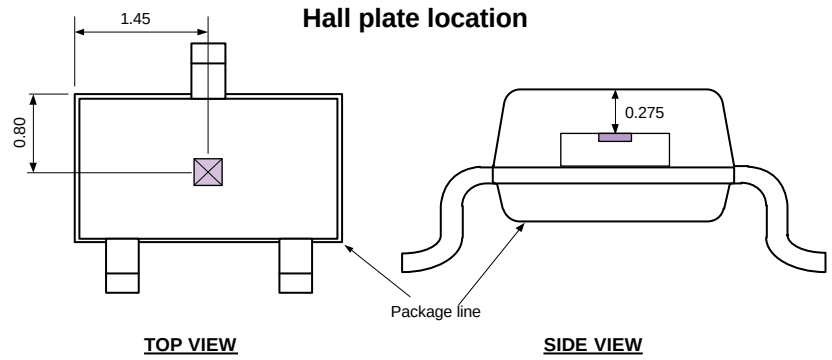
WWYY
WW: Calendar Week
YY: Calendar Year

	A	A1	A2	D	E	E1	L	b	c	e	e1	α
min	–	0.025	0.85	2.80	2.60	1.50	0.30	0.30	0.10	0.95	1.90	0°
max	1.00	0.10	0.90	3.00	3.00	1.70	0.50	0.45	0.20	BSC	BSC	8°

Notes:

1. Dimension “D” and “E1” do not include mold flash or protrusions. Mold flash or protrusion shall not exceed 0.15mm on “D” and 0.25mm on “E” per side.
2. Dimension “b” does not include dambar protrusion.

12.4. SE (TSOT-3L) Hall Plate Location



13. Standard Information

Our products are classified and qualified regarding soldering technology, solderability and moisture sensitivity level according to standards in place in Semiconductor industry.

For further details about test method references and for compliance verification of selected soldering method for product integration, Melexis recommends reviewing on our web site the General Guidelines soldering recommendation. For all soldering technologies deviating from the one mentioned in above document (regarding peak temperature, temperature gradient, temperature profile, etc.), additional classification and qualification tests have to be agreed upon with Melexis.

For package technology embedding trim and form post-delivery capability, Melexis recommends to consult the dedicated trim & form recommendation application note: lead trimming and forming recommendations.

Melexis is contributing to global environmental conservation by promoting **lead free** solutions. For more information on qualifications of **RoHS** compliant products (RoHS = European directive on the Restriction Of the use of certain Hazardous Substances) please visit the quality page on our website: http://www.melexis.com/en/quality-environment.

14. ESD Precautions

Electronic semiconductor products are sensitive to Electro Static Discharge (ESD).
Always observe Electro Static Discharge control procedures whenever handling semiconductor products.

15. Contact

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For additional information, please contact our Direct Sales team and get help for your specific needs:

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Revision History Table

Rev 001	6-Oct-2014	Document Creation
Rev 002	22-May-2019	Update to new Melexis branding template
Rev 003	15-Apr-2020	Updated UA package outline drawing to current format Added versions placed into production since latest update Updated block diagram to standard Melexis format and colors Added Automotive AEC Q-100 qualified note under "Features and Benefits"
	23-Apr-2020	Updated 3D package drawings in section 6
Rev 004	1-Mar-2021	Added MLX90290LSE-AAA-522-RE to the standard available options Package outline dimensions for UA package updated Hall plate location updated from 0.44±0.04 to 0.44±0.03 Added note regarding lead coplanarity and pitch in bulk packaging
Rev 005	21-Jun-2021	Added MLX90290LUA-AAA-553-BU to the standard available options Converted UA tape drawing to vector format for clarity

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